COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP9668</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td></td>
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<td></td>
<td>IGNORE -&gt; Bottom Overlay</td>
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<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 4/15/2014  7:32:47 AM</td>
<td></td>
<td>TEXAS INSTRUMENTS</td>
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